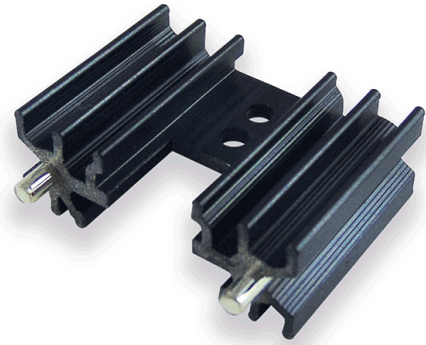


Product Data Sheet Type: PR28/25/SE

Group: HEATSINKS Board Level

For single mounting

Width : 34.8 mm
 Height : 12.5 mm
 Length : 25 mm
 Minimum thermal resistance : 13 K/W
 For device : TO 220|TO 218|TOP 3|TO
 Device mounted by : Screw
 Heatsink mounted by :
 Surface :
 Material : AlMgSi0,5



- Special extruded heatsink for semiconductor case TO220, TO202, TO218(TOP3)
- Aluminium, anodised black, solderable
- Standard heights: 25, 38, 50 and 63 mm
- 2 x 3.2 mm holes for semiconductor assembly
- Heatsink solderable by tin plated solder pins

